REISSUE PATENT APPLICATION TRANSMITTAL							
Add	dress to: Mail Stop Reissue	Attorney Docket No. FI 9-97-207 US2  First Named Inventor Cyprian Emeka Uzoh					
7.00	Commissioner for Patents	6 207 140 P4					
	P.O. Box 1450 Alexandria, VA 22313-1450	Original Patent Number 0,297,140 B1 C					
	·	Original Patent Issue Date (Month/Day/Year) 10/02/01					
		Express Mail Label No.					
APF	PLICATION FOR REISSUE OF: (check applicable box)      X   Utility Pater	Express Mail Label No.  Design Patent Plant Patent					
	APPLICATION ELEMENTS (37 CFR 1.173)	ACCOMPANYING APPLICATION PARTS					
1.	X Fee Transmittal Form (PTO/SB/56) (Submit an original, and a duplicate for fee processing)	10. X Statement of status/support for all changes to the claims. See 37 CFR 1.173(c).					
2.	Applicant claims small entity status. See 37 CFR 1.27.	11. Original U.S. Patent for surrender					
3.	x Specification and Claims in double column copy of patent format (amended, if appropriate)	Ribboned Original Patent Grant					
4.	X Drawing(s) (proposed amendments, if appropriate)	Statement of Loss (PTO/SB/55)					
5.	Reissue Oath/Declaration (original or copy) (37 CFR § 1.175)(PTO/SB/51 or 52)	12. Foreign Priority Claim (35 U.S.C. 119) (if applicable)					
6.	X Power of Attorney 13. Information Disclosure Copies of II						
7.	Original U.S. Patent currently assigned?	Statement (IDS)/PTO-1449 Citations					
	X Yes No	English Translation of Reissue Oath/Declaration (if applicable)					
	(If Yes, check applicable box(es))	15. X Preliminary Amendment					
	Written Consent of all Assignees (PTO/SB/53)	16. Return Receipt Postcard (MPEP 503) (Should be specifically itemized)					
	37 CFR 3.73(b) Statement (PTO/SB/96)	17. Other: Copy of Certificate of Correction					
8.	CD-ROM or CD-R in duplicate, Computer Program (Appendix) or large table	Offer to surrender original patent Request for transfer of drawings					
9.	Nucleotide and/or Amino Acid Sequence Submission (if applicable, all of the following are necessary)						
	a. Computer Readable Form (CFR)						
	b. Specification Sequence Listing on:						
	i. CD-ROM (2 copies) or CD-R (2 copies); or	ii. Paper					
c. Statements verifying identify of above copies							
	18. CORRESPOI	IDENCE ADDRESS					
[ }	Customer Number or Bar Code Label	or Correspondence address below					

Name				
Address				
City		State	Zip Co	ode
Country		Telephone		Fax
Name (Print/Type)	Burton A. Amernick		Registration No. (Attorney/Agent	t) 24,852
Signature	Builta Clar		Date	10-2-03



## REISSUE APPLICATION FEE TRANSMITTAL FORM

24,852 Registration Number, if applicable Docket Number (Optional) FI9-97-207 US2

Burton A. Amernick
Typed or printed name

					C	lair	ns as Fi	led – Pa	ırt 1							
Claims in Number Filed			(3)		Small En		Entity I	tity		Other than a		Small Entity				
Patent	T-4-1 CI-		Reissue Ap	plication	Number Ex	tra	Rate F		ee	ļ		Rate	Fee			
(A) 23	Total Cla (37 CFR 1	.16(j))	(B)	23	3	=	x \$	=			or	x \$	18 =		54.	
(C) 2	Independent (37 CFR 1		(D)	2	. 0	=	x \$	=				x \$	86 =			
			В	sic Fee (37 CFR 1.16(h)) \$			) \$						\$		770.0	
					Total Filin	ıg F	ee	\$					OR	\$		824.0
					Cla	ims	as Ame	nded –	Part 2							
		Claims	(1) laims Remaining		(2) Highest No.		(3) Extra		Carall Easier			Other than a Small En		:4		
			mendment		Previously		Claims	Pat	Small Enti				Rate		Fee	
Tota	I Claims				Paid For	+	Present			Fe		$\dashv$				
(37 CF	R 1.16(j))	***	62	MINUS	23	*	= 39	x \$	=			_	×\$ 18	=		702.0
	ndent claims R 1.16(i))	***	2	MINUS	3		= 0	x \$	=				×\$ 86	=		0.0
						Т	otal Addit	ional Fee	\$				OR		\$	702.0
*** After a **** If "A"  ***** "High	Highest Numb any cancellati is greater tha hest Number of Applicant cla	on of cla n 20, us of Indep	aims. e (B-A); if "/ endent Clai	A" is 20 o	r less, use (E ously Paid F	3-20 or" (	<b>)</b> ).			·		itent	(C).			
x -	Please char A duplicate The Director credit any o	copy of	oosit Accor f this shee eby author ment to De	unt No. t is enclorized to deposit Ad	09 osed. charge any ccount No.	-04	158 ditional	-		unt of <u>s</u>		r 1.1	1526.00	y be	_· required	d, or

#### IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Reissue Patent Application of: Cyprian Emeka Uzoh et al.	
Reissue Application No.: Not Yet Known (U.S. Patent 6,297,140)	Group Art Unit: Not Yet Known
Filed: Concurrently Herewith (October 2, 2001)	Examiner: Not Yet Known

## STATUS OF CLAIMS AND SUPPORT FOR CLAIM CHANGES

MS REISSUE Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

1.	The Status of the claim as a result of the amendment submitted herewith is:					
	Claims cancelled:					
	Claims amended: 1, 16, 20, 22 and 23					
	Claims added: 24 to 62					

2. Explanation of/or support of new claims or amendments to claims:

Claims 1, 16, 20, 22 and 23 have also been amended by deleting the phrase "the steps of" or "the step of" which seems superfluous.

This is a broadened reissue in view of newly-presented claims 24-43. The broadening is directed to not reciting "depositing a photoresist layer over said plating seed layer" and "remaining portions of said photoresist layer" and "removing photoresist remaining in said at least one recess "contained in Patent Claim 1 and claims dependent therein or not reciting "providing a pad in said at least one recess for preventing removal of portions of said seed layer in said at least one recess" and "removing said pad" included in Patent Claim 22 and claims dependent thereon. Not requiring the above features is supported by the original patent. For instance, although these features relate to referred aspects of the invention in order to assure the preventing of dishing of the seed layer in the depression, they are not mandatory. In particular, the disclosure at column 6, lines 3-4 and 42-44 disclose the optional nature of these embodiments.

For instance, column 6, lines 3-4 state:

"After formation of the seed layer, a photoresist may be deposited over the seed layer."

Column 6, lines 42-44 state:

"According to an alternative embodiment, photoresist may not be utilized. Since an embodiment may utilize a very hard pad to prevent dishing of the seed layer in the depression."

The use of the term "may" with the above statements is a clear appreciation and recognition that the method is being practiced without employing these steps. This is further supported by column 6, line 53 that states

"After removal of the resist, if necessary . . ."

Newly presented claims 44-62 generally correspond to claim 2-12 and 14-21, respectively except that they ultimately depend upon claim 22 rather than ultimately from Claim 1. Claim 54 further differs from Claim 12 in not reciting the "photoresist layer."

Dated: 10-2-03

Respectfully submitted,

Burton A. Amernick, Registration No.: 24,852

CONNOLLY BOVE LODGE & HUTZ LLP 1990 M Street, N.W., Suite 800

Washington, DC 20036-3425

(202) 331-7111

(202) 293-6229 (Fax)

### IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Reissue Patent Application of:

Cyprian Emeka Uzoh et al.

Reissue Application No.: Not Yet Known

(U.S. Patent 6,297,140)

Group Art Unit: Not Yet Known

Filed: Concurrently Herewith

(October 2, 2001)

Examiner: Not Yet Known

## OFFER TO SURRENDER ORIGINAL PATENT GRANT

MS REISSUE Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

Reissue Applicants hereby offer to surrender the original Letters Patent for U.S. Patent No. 6,297,140 B1 upon the allowance of this Reissue application.

Dated: [0-2-03

Respectfully submitted A

Burton A. Amernick, Registration No.: 24,852

CONNOLLY BOVE LODGE & HUTZ LLP

1990 M Street, N.W., Suite 800 Washington, DC 20036-3425

(202) 331-7111

(202) 293-6229 (Fax)

### IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Reissue Patent Application of:

Cyprian Emeka Uzoh et al.

Reissue Application No.: Not Yet Known

(I.S. Detect 6 207 140)

Group Art Unit: Not Yet Known

(U.S. Patent 6,297,140)

Filed: Concurrently Herewith

(October 2, 2001)

Examiner: Not Yet Known

# REQUEST FOR TRANSFER OF DRAWINGS FROM ORIGINAL PATENT TO REISSUE APPLICATION

Commissioner for Patents P. O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

Please transfer the drawings from original patent, 6,297,140, filed on September 3, 1999, for the invention entitled "Method to Plate C4 to Copper Stud" to the reissue application, the specification of which is attached hereto.

Date: (0-2-03

Respectfully submitted,

Burton A. Amernick Registration No.: 24,852

CONNOLLY BOVE LODGE & HUTZ LLP

1990 M Street, N.W., Suite 800 Washington, DC 20036-3425

(202) 331-7111

(202) 293-6229 (Fax)

Attorney for Applicants

## UNITED STATES PATENT AND TRADEMARK OFFICE **CERTIFICATE OF CORRECTION**

PATENT NO. : 6,297,140 B1 DATED

: October 2, 2000

Page 1 of 1

INVENTOR(S) : Uzoh et al.

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

Column 2, Line 48, delete "is" (second occurrence).

Column 5,

Line 38, after "may" insert -- be --.

Line 3, after "may" insert -- be --.

Line 24, delete "the" (first occurrence).

Line 65, after "continued" insert -- until --.

Signed and Sealed this

Twenty-fifth Day of June, 2002

Attest:

Attesting Officer

JAMES E. ROGAN

Director of the United States Patent and Trademark Office